

Final Product Change Notification

Issue Date: 09-Jan-2019 Effective Date: 15-Apr-2019

UPDATE

Here's your personalized quality information concerning products Digi-Key purchased from Nexperia.

For detailed information we invite you to view this notification online



Management Summary

Change the die of the PBSSx350Z to the known 1160x810µm² pitch with glue back metal.

Change Category

Orlange Gategory				
[X] Wafer Fab Process	[X] Assembly	y[] Product Marking	[] Test	[X] Design
	Process		Location	
[X] Wafer Fab Materials	[X] Assembly	y[] Mechanical	[]Test	[] Errata
	Materials	Specification	Process	
[] Wafer Fab Location	[] Assembly	[]	[]Test	[] Electrical
	Location	on Packing/Shipping/Labeling Equipmer		spec./Test
				coverage

Change of die size and attach technology for PBSSx350Z

Details of this Change

Change die attach from eutectic to glue die attach and shrink of die size for 50 V, 3 A BISS transisators in SOT223.

Additionally PBSS5350Z will be released to use 8 inch wafer diameter.

Why do we Implement this Change

To increase flexibility and volume ramp-up.

Identification of Affected Products

The products using a chip from a 8 inch wafer can be identified by a marker on the die surface. Changed products can be identified by date code after implementation.

Product Availability

Sample Information

Samples are available upon request

Latest sample request date for PCN samples is 31-Jan-2019

Production

Planned first shipment 15-Apr-2019

Update Information

This update informs about the new contact address for PCN-related questions.

The content and schedule of this notification is not affected by this update.

Impact

No impact to the products' functionality anticipated.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC J-STD-046, is expected till 08-Feb-2019. Lack of acknowledgement of the PCN constitutes acceptance of the change.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact Nexperia "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local Nexperia Sales Support team.

At Nexperia B.V. we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

About Nexperia B.V.

We at Nexperia are the efficiency semiconductor company. We deliver over 70 billion products a year and as such service thousands of global customers, both directly and through our extensive network of channel partners. We are at the heart of billions of electronic devices in the Automotive, Mobile, Industrial, Consumer, Computing, and Communication Infrastructure segments.

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Affected Part Numbers

PBSS4350Z,135

PBSS5350Z,135